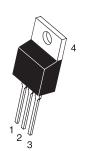
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Description:

These devices are designed for use in general-purpose amplifier and switching applications.

Features:

- DC Current Gain Specified to 7A hfe = 30-150 @ Ic
- Collector-Emitter Sustaining Voltage VcEo(sus) = 50 V DC (Min)
- High Current Gain Bandwidth Product f τ = 10MHz (Min) @ Ic = 500mA DC
- TO-220AB Compact Package

Pin Configuration

- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector

Maximum Ratings

Characteristic	Symbol	Value	Unit	
Collector-Emitter Voltage	V _{CEO}	50		
Collector-Base Voltage	V _{CBO}	60	V DC	
Emitter-Base Voltage	V _{EBO}	5		
Collector Current-Continuous -Peak	I _c	7 10	A DC	
Base Current	I _B	3	7,50	
Total Power Dissipation at T _C = 25°C Derate above 25°C	P _D	40 0.32	W W/°C	
Operation and Storage Junction Temperature Range	T _J , T _{STG}	-65 to +150	°C	

Thermal Characteristics

Characteristic	Symbol	Max.	Unit
Thermal Resistance Junction to Case	$R_{\scriptscriptstyle{ hetajc}}$	3.125	°C/W

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Electrical Characteristics (T_c = 25°C unless otherwise noted)

Characteristic	Symbol	Min.	Max.	Unit
Off Characteristics				•
Collector-Emitter Sustaining Voltage (1*) $I_C = 100$ mA DC, $I_B = 0$	V _{CEO (sus)}	50	-	V DC
Collector Cut off Current $V_{CE} = 40V DC$, $I_{B} = 0$	I _{CEO}	-	1	mA DC
Collector Cut off Current $V_{CE} = 60 \text{V DC}, V_{EB(off)} = 1.5 \text{V DC}$ $(V_{CE} = 50 \text{V DC}, V_{EB(off)} = 1.5 \text{V DC}, T_{C} = 150 ^{\circ}\text{C})$	I _{CEX}	-	100 2	μΑ DC mA DC
Emitter Cut off Current $V_{EB} = 5V DC, I_{C} = 0$	I _{EBO}	-	1	mA DC
On Characteristics (1*)				
DC Current Gain $I_C = 2.5A DC, V_{CE} = 4V DC$ $I_C = 7A DC, V_{CE} = 4V DC$	h _{FE}	30 2.3	150 -	-
Collector-Emitter Saturation Voltage $I_C = 7A DC$, $I_B = 3A DC$	V _{CE (sat)}	-	3.5	V DC
Base-Emitter On Voltage $I_C = 7ADC$, $V_{CE} = 4VDC$	V _{BE (on)}	-	3	V DC
Dynamic Characteristics		,		,
Current Gain - Bandwidth Product (2*) $I_C = 500$ mA DC, $V_{CE} = 4$ V DC, $f_{test} = 1$ MHz	f _⊤	10		MHz
Output Capacitance ($V_{CB} = 10V DC$, $I_E = 0$, $f = 1MHz$)	C _{ob}	-	250	pF
Small-Signal Current Gain	h.	20	_	_

^{1* =} Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.

 $(I_C = 0.5A DC, V_{CE} = 4V DC, f = 50kHz)$

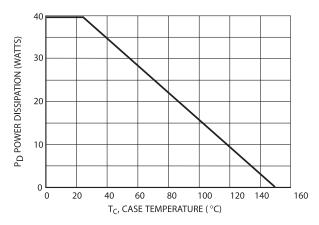


Figure 1. Power Derating

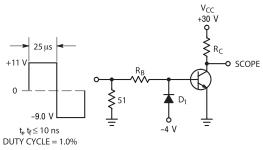
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 $[\]mathbf{2^*} = \mathbf{f}_{\scriptscriptstyle \top} = |\mathsf{hfe}| \cdot \mathbf{f}_{\scriptscriptstyle \mathsf{test}}$

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 $R_{\mbox{\footnotesize{B}}}$ and $R_{\mbox{\footnotesize{C}}}$ ARE VARIED TO OBTAIN DESIRED CURRENT LEVELS

D1 MUST BE FAST RECOVERY TYPE, eg: 1N5825 USED ABOVE $I_{B}\approx100$ mA MSD6100 USED BELOW $I_{B}\approx100$ mA

 $V_{CC} = 30 V$ 0.7 $I_{C}/I_{B} = 10$ 0.5 t, TIME (µs) 0.2 0.1 0.07 t_d @ V_{BE(off)}* 0.05 0.03 0.02 0.3 0.5 5.0 I_C, COLLECTOR CURRENT (AMP)

Figure 3. Turn-On Time

Figure 2. Switching Time Test Circuit

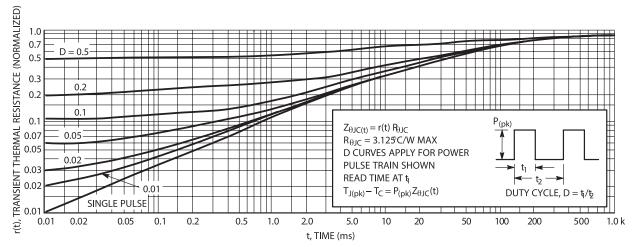


Figure 4. Thermal Response

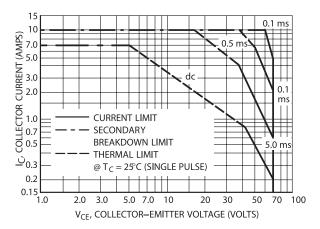


Figure 5. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate Ic – VcE limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150^{\circ}C$; Tc is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown

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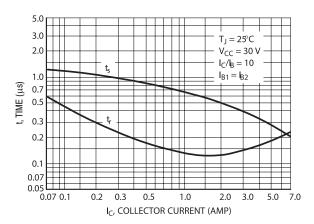


Figure 6. Turn-Off Time

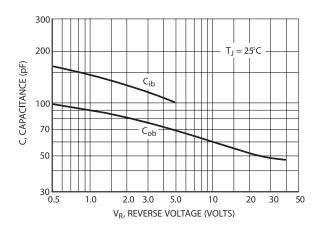
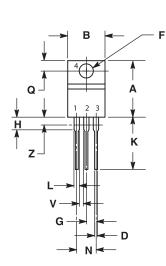
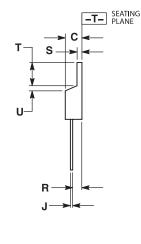


Figure 7. Capacitance





Pin Configuration

- 1. Base
- 2. Collector
- 3. Emitter
- Collector

Dimensions	Min.	Max.
Α	14.48	15.75
В	9.66	10.28
С	4.07	4.82
D	0.64	0.88
F	3.61	3.73
G	2.42	2.66
Н	2.8	3.93
J	0.46	0.64
K	12.7	14.27
L	1.15	1.52
N	4.83	5.33
Q	2.54	3.04
R	2.04	2.79
S	1.15	1.39
Т	5.97	6.47
U	0	1.27
V	1.15	
Z	-	2.04

Part Number Table

Description	Part Number
Transistor, PNP, TO-220	2N6109

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